

◆ DESCRIPTION

The MT3400 is the N-Channel logic enhancement mode power field effect transistor is produced using high cell density, DMOS trench technology. This high-density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high side switching.

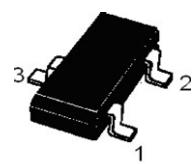
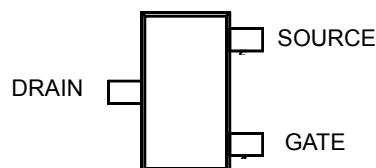
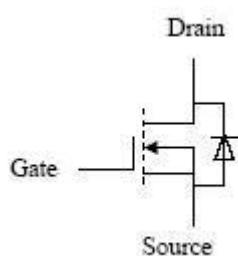
◆ FEATURES

- 30V/5.8A, $R_{DS(ON)} = 38 \text{ m}\Omega$ @ $V_{GS} = 10\text{V}$
- 30V/5.0A, $R_{DS(ON)} = 42 \text{ m}\Omega$ @ $V_{GS} = 4.5\text{V}$
- 30V/4.0A, $R_{DS(ON)} = 55 \text{ m}\Omega$ @ $V_{GS} = 2.5\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

◆ APPLICATIONS

- POWER Management in Note
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
-

◆ PIN CONFIGURATION



◆ ABSOLUTE MAXIMUM RATINGS

($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Maximum	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	12	V
Continuous Drain Current	I_D	5.8	A
		4.9	
Pulsed Drain Current	I_{DM}	30	A
Power Dissipation	P_D	1.4	W
		0.9	
Maximum Body-Diode Continuous Current		2.5	A
Operating junction temperature range	T_J	150	$^\circ\text{C}$
Storage temperature range	T_{STG}	- 55 to 150	$^\circ\text{C}$

◆ THERMAL RESISTANCE RATINGS

Parameter	Symbol	Maximum	Unit
Junction-to-Ambient	$R_{\theta JA}$	90	$^\circ\text{C}/\text{W}$

◆ ELECTRICAL CHARACTERISTICS

($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	30	-	-	V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	0.7	-	1.4	V
Gate Leakage Current	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$	-	-	1	μA
		$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}, T_J = 55^\circ\text{C}$	-	-	5	
On-State Drain Current	$I_{D(\text{ON})}$	$V_{DS} \leq 5\text{V}, V_{GS} = 4.5\text{V}$	5.8	-	-	A
Drain-Source On Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 2.5\text{V}, I_D = 4.0\text{A}$	-	47	55	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 5.0\text{A}$	-	37	42	
		$V_{GS} = 10\text{V}, I_D = 5.8\text{A}$	-	33	38	
Diode Forward Voltage	V_{SD}	$I_S = 1.0\text{A}, V_{GS} = 0\text{V}$	-	0.7	1.1	V
Dynamic Parameters						
Total Gate Charge	Q_g	$V_{DS} = 15\text{V}, V_{GS} = 4.5\text{V}, I_D = 5.8\text{A}$	-	9.7	12	nC
Gate-Source Charge	Q_{gs}		-	1.6	-	
Gate-Drain Charge	Q_{gd}		-	3.1	-	
Turn-On Time	$T_{D(\text{ON})}$	$V_{DS} = 10\text{V}, V_{GS}=10\text{V}, R_L = 2.7\Omega, V_{GEN} = 4.5\text{V}$	-	3.3	5	nS
	t_r		-	4.8	7	
Turn-Off Time	$T_{D(\text{OFF})}$		-	26.3	40	
	T_f		-	4.1	6	



◆ TYPICAL CHARACTERISTICS

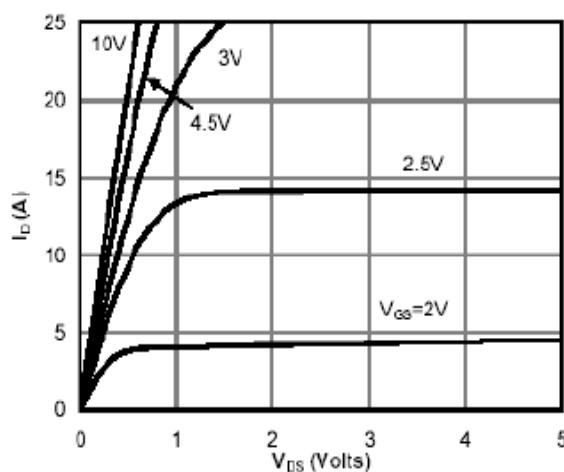


Fig 1: On-Region Characteristics

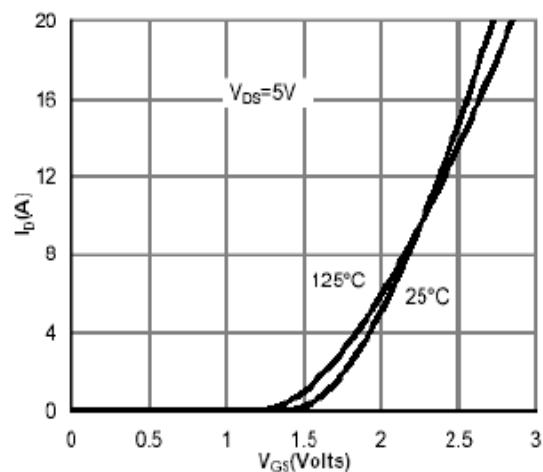


Figure 2: Transfer Characteristics

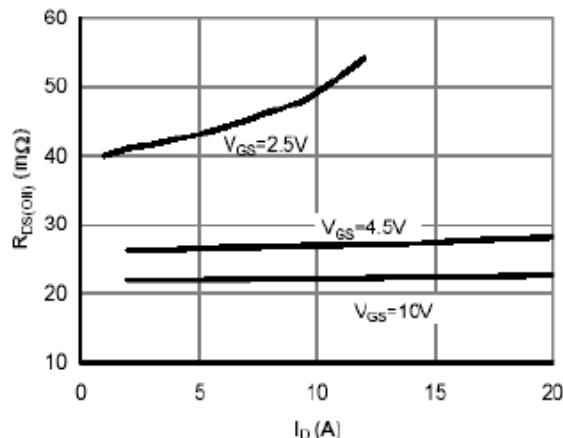


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

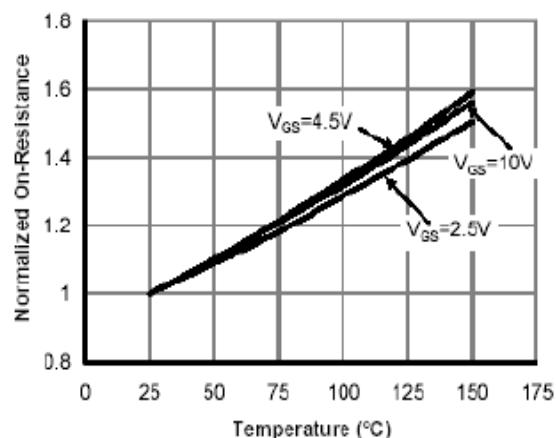


Figure 4: On-Resistance vs. Junction Temperature

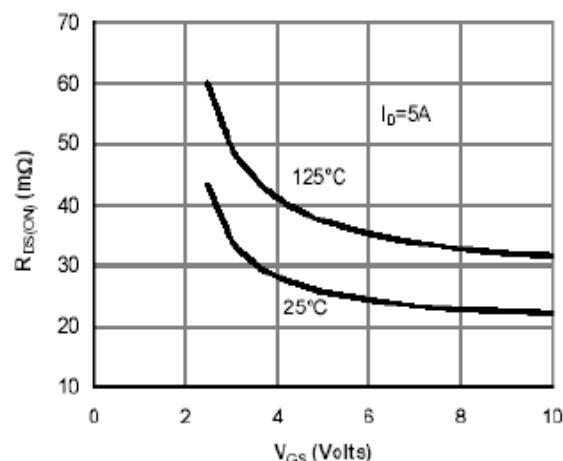


Figure 5: On-Resistance vs. Gate-Source Voltage

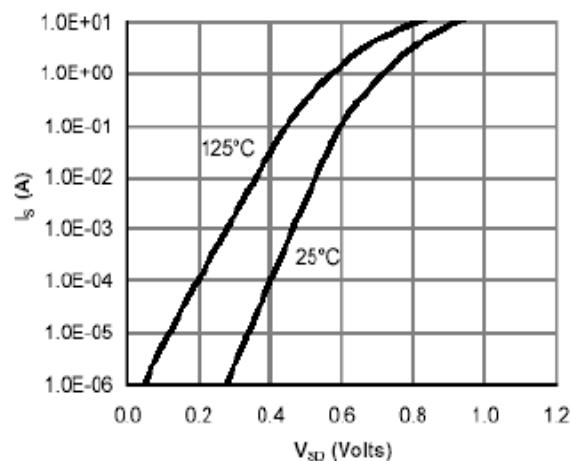


Figure 6: Body-Diode Characteristics



◆ TYPICAL CHARACTERISTICS

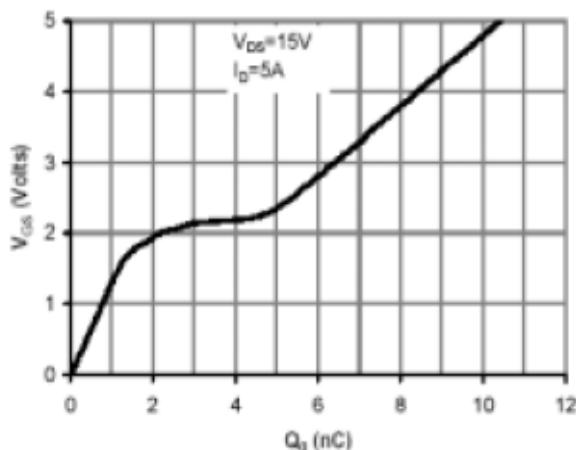


Figure 7: Gate-Charge Characteristics

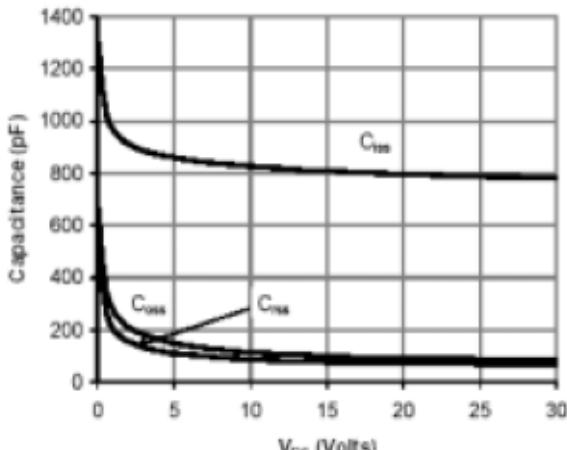


Figure 8: Capacitance Characteristics

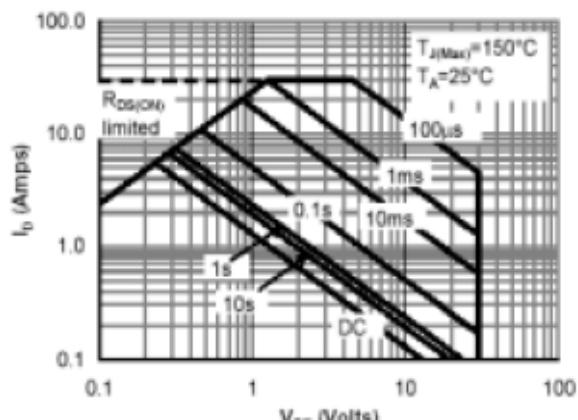


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

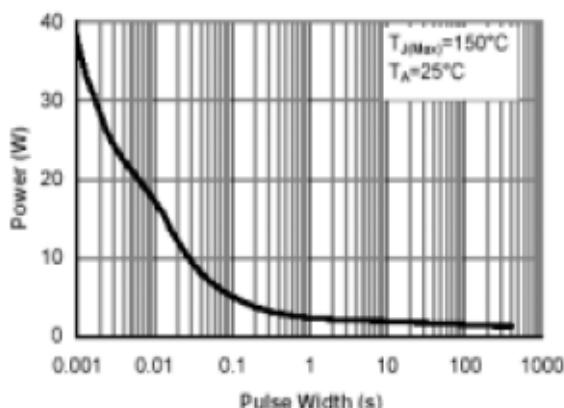


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

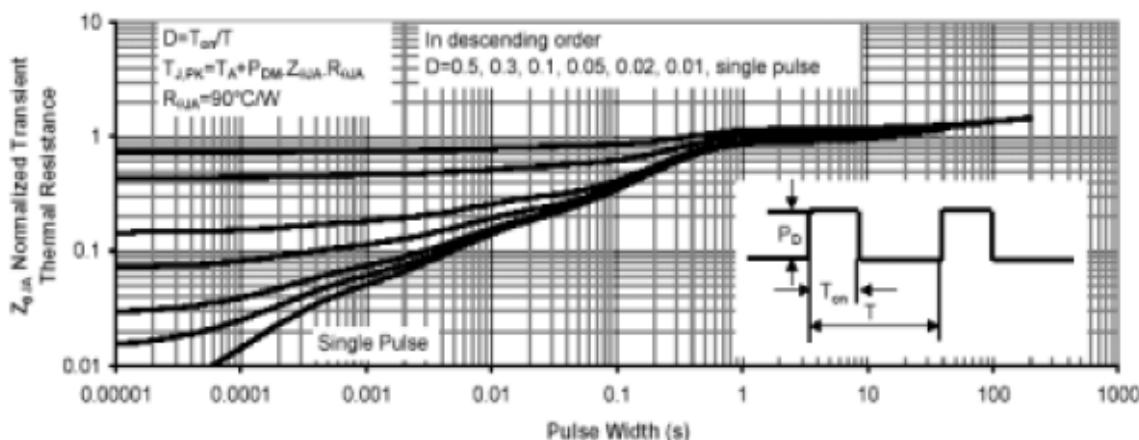
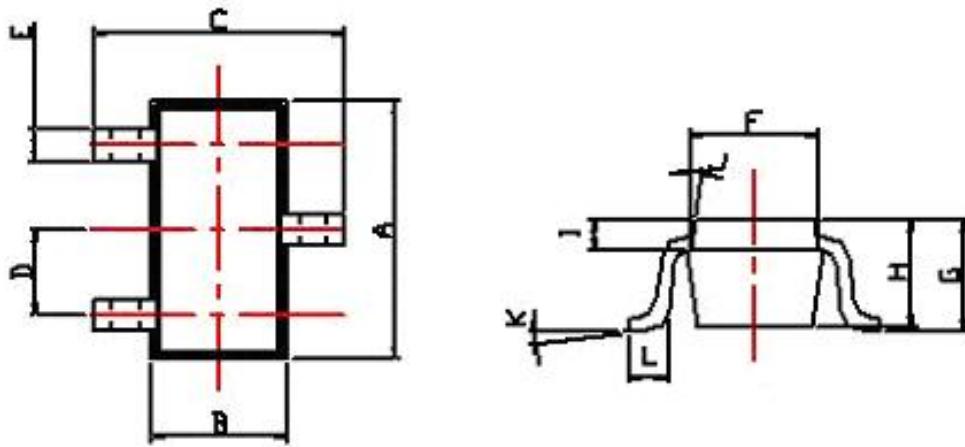


Figure 11: Normalized Maximum Transient Thermal Impedance



◆ PHYSICAL DIMENSIONS

3-Pin surface Mount SOT-23



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.70	3.10	G	0.9	1.4
B	1.20	1.66	H	0.8	1.30
C	2.37	2.90	I	0.25	0.7
D	0.85	1.15	J	$7 \pm 2^\circ$.	
E	$0.350 + 0.15/-0.05$		K	$0 \sim 10^\circ$.	
F	1.07	1.53	L	0.2 (MIN)	